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T,	Hits	Search Text	DB	Time stamp
L Number	nics	Search lext	DD	12mo Soump
	30183	micromachin\$3 or microelectromechanic\$3	USPAT;	2003/03/03
1	30103	or micro adj2 device	US-PGPUB;	17:25
		or micro adje device	JPO;	1,,20
	}		DERWENT;	
			IBM TDB	
	34227	(micromachin\$3 or microelectromechanic\$3	USPAT;	2003/03/03
2	34227	or micro adj2 device) or micro adj1	US-PGPUB;	17:21
		machin\$3 or micro adj1 electromechanic\$3	JPO;	17.21
İ		machinas or micro adji electromechanicas	DERWENT;	<u> </u>
			IBM TDB	
_	24460	// i	USPAT;	2003/03/03
3	34468	((micromachin\$3 or microelectromechanic\$3	US-PGPUB;	17:24
		or micro adj2 device) or micro adj1	JPO;	17.29
		machin\$3 or micro adj1 electromechanic\$3		
		) or (thermo adj2 optic\$4 or	DERWENT;	
		thermooptic\$4) adj3 switch\$3	IBM_TDB	2003/03/03
4	775440	gap\$3	USPAT;	17:26
			US-PGPUB;	17:26
			JPO;	
			DERWENT;	
			IBM_TDB	0000 (00 (00
5	3410	thermal\$3 near20 isolat\$4 near20	USPAT;	2003/03/03
		substrate	US-PGPUB;	17:27
			JPO;	1
			DERWENT;	
			IBM_TDB	
6	89	gap\$3 same (thermal\$3 near20 isolat\$4	USPAT;	2003/03/03
		near20 substrate)	US-PGPUB;	17:27
			JPO;	
	İ		DERWENT;	
			IBM_TDB	/
7	28	(gap\$3 same (thermal\$3 near20 isolat\$4	USPAT;	2003/03/03
		near20 substrate)) and (((micromachin\$3	US-PGPUB;	17:27
		or microelectromechanic\$3 or micro adj2	JPO;	
		device) or micro adj1 machin\$3 or micro	DERWENT;	-
		adj1 electromechanic\$3 ) or (thermo adj2	IBM_TDB	
		optic\$4 or thermooptic\$4) adj3 switch\$3)	]	

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L	Hits	Search Text	DB	Time stamp
Number 1	30183	micromachin\$3 or microelectromechanic\$3 or micro adj2 device	USPAT; US-PGPUB; JPO; DERWENT;	2003/03/03 17:25
2	34227	(micromachin\$3 or microelectromechanic\$3 or micro adj2 device) or micro adj1 machin\$3 or micro adj1 electromechanic\$3	IBM_TDB USPAT; US-PGPUB; JPO; DERWENT; IBM TDB	2003/03/03 17:21
3	34468	((micromachin\$3 or microelectromechanic\$3 or micro adj2 device) or micro adj1 machin\$3 or micro adj1 electromechanic\$3 ) or (thermo adj2 optic\$4 or	USPAT; US-PGPUB; JPO; DERWENT; IBM TDB	2003/03/03 17:24
4	775440	thermooptic\$4) adj3 switch\$3 gap\$3	USPAT; US-PGPUB; JPO; DERWENT;	2003/03/03 17:26
5	3410	thermal\$3 near20 isolat\$4 near20 substrate	IBM_TDB USPAT; US-PGPUB; JPO; DERWENT;	2003/03/03 17:27
6	89	<pre>gap\$3 same (thermal\$3 near20 isolat\$4 near20 substrate)</pre>	IBM_TDB USPAT; US-PGPUB; JPO; DERWENT;	2003/03/03 17:27
7	. 28	(gap\$3 same (thermal\$3 near20 isolat\$4 near20 substrate)) and (((micromachin\$3 or microelectromechanic\$3 or micro adj2 device) or micro adj1 machin\$3 or micro adj1 electromechanic\$3) or (thermo adj2 optic\$4 or thermooptic\$4) adj3 switch\$3)	IBM_TDB USPAT; US-PGPUB; JPO; DERWENT; IBM_TDB	2003/03/03 17:32
8	18813	thermal\$3 near20 isolat\$4	USPAT; US-PGPUB; JPO; DERWENT; IBM TDB	2003/03/03 17:33
9	760	gap\$3 same (thermal\$3 near20 isolat\$4)	USPAT; US-PGPUB; JPO; DERWENT; IBM TDB	2003/03/03
10	55	(gap\$3 same (thermal\$3 near20 isolat\$4)) and (((micromachin\$3 or microelectromechanic\$3 or micro adj2 device) or micro adj1 machin\$3 or micro adj1 electromechanic\$3 ) or (thermo adj2 optic\$4 or thermooptic\$4) adj3 switch\$3)	USPAT; US-PGPUB; JPO; DERWENT; IBM_TDB	2003/03/03 17:33
11	27	((gap\$3 same (thermal\$3 near20 isolat\$4)) and (((micromachin\$3 or microelectromechanic\$3 or micro adj2 device) or micro adj1 machin\$3 or micro adj1 electromechanic\$3 ) or (thermo adj2 optic\$4 or thermooptic\$4) adj3 switch\$3))	USPAT; US-PGPUB; JPO; DERWENT; IBM_TDB	2003/03/03 17:34
,		not ((gap\$3 same (thermal\$3 near20 isolat\$4 near20 substrate)) and (((micromachin\$3 or microelectromechanic\$3 or micro adj2 device) or micro adj1 machin\$3 or micro adj1 electromechanic\$3) or (thermo adj2 optic\$4 or thermooptic\$4) adj3 switch\$3))		

L	Hits	Search Text	DB	Time stamp
Number 1	1283145	gap\$3 or cavit\$3	USPAT;	2003/03/04
_		9	US-PGPUB;	10:21
	İ		JPO;	
			DERWENT;	
		·	IBM_TDB	
2	2471169		USPAT;	2003/03/04
		oxide or dioxide	US-PGPUB;	10:22
			JPO;	
	1		DERWENT;	
			IBM_TDB	0000 (00 (00
3	3190100	etch\$3 or remov\$3	USPAT;	2003/03/04
			US-PGPUB;	10:23
			JPO;	
			DERWENT;	
			IBM_TDB	2002/02/04
4	18813	thermal\$3 near20 isolat\$4	USPAT;	2003/03/04
			US-PGPUB;	10:25
			JPO;	
			DERWENT;	1
_	120	/ 63	IBM_TDB   USPAT;	2003/03/04
5	128	(gap\$3 or cavit\$3) same (insulat\$3 or dielectric or sio2 or sio or oxide or	US-PGPUB;	10:26
		dioxide) same (etch\$3 or remov\$3) same	JPO;	10.20
		(thermal\$3 near20 isolat\$4)	DERWENT;	
		(Chermarys hearso isolacy)	IBM TDB	
6	34227	((micromachin\$3 or microelectromechanic\$3	USPAT:	2003/03/04
٥	34227	or micro adj2 device) or micro adj1	US-PGPUB;	10:29
		machin\$3 or micro adj1 electromechanic\$3	JPO;	
	•	) or (thermo adj2 optic\$4 or	DERWENT;	
		thermooptic\$4) adj3 switch\$3 and ((gap\$3	IBM TDB	
		or cavit\$3) same (insulat\$3 or dielectric	_	•
		or sio2 or sio or oxide or dioxide) same		
		(etch\$3 or remov\$3) same (thermal\$3		
		near20 isolat\$4))		
7	34468	((micromachin\$3 or microelectromechanic\$3	USPAT;	2003/03/04
		or micro adj2 device) or micro adj1	US-PGPUB;	10:33
		machin\$3 or micro adj1 electromechanic\$3	JPO;	
		) or (thermo adj2 optic\$4 or	DERWENT;	
	1	thermooptic\$4) adj3 switch\$3	IBM_TDB	0000 (00 (04
8	32		USPAT;	2003/03/04
		dielectric or sio2 or sio or oxide or	US-PGPUB;	10:33
	1	dioxide) same (etch\$3 or remov\$3) same	JPO;	
	1	(thermal\$3 near20 isolat\$4)) and	DERWENT;	
	1	(((micromachin\$3 or	IBM_TDB	
		microelectromechanic\$3 or micro adj2 device) or micro adj1 machin\$3 or micro		
		adj1 electromechanic\$3 ) or (thermo adj2		
	1	optic\$4 or thermooptic\$4) adj3 switch\$3)		
	ı	Obstock of sustinophotosky and switches)	I	